

10/810,779

In the Specification

Please amend the title as follows:

Circuit Constructions, ~~and Methods of Forming Regions of Differing Composition~~  
~~Over a Substrate~~

At page 1, before the "Technical Field" section, insert:

RELATED PATENT DATA

*De* This patent resulted from a divisional application of U.S. Patent Application Serial  
No. 10/443,354, <sup>now PAT 6,786,766</sup> which was filed May 21, 2003, which is a continuation-in-part application  
of U.S. Patent Application Serial No. 10/243,386, <sup>now PAT 6,767,806</sup> filed September 13, 2002; which is a  
divisional application of U.S. Patent Application Serial No. 09/827,759, filed April 6, 2001  
and now U.S. Patent Number 6,511,896.